

60V, 178A, 2.4m Ω N-channel Power SGT MOSFET

JMSH0602PC

Features

- $\bullet \quad \text{Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge}$
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant
- Pb-free plating

Applications

- Load Switch
- PWM Application
- Power Management

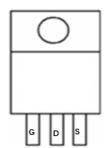
Product Summary

| Parameters | Value | Unit |
|-------------------------------|-------|------|
| V_{DSS} | 60 | ٧ |
| $V_{GS(th)_Typ}$ | 2.9 | ٧ |
| $I_D(@V_{GS}=10V)$ | 178 | Α |
| $R_{DS(ON)_Typ}(@V_{GS}=10V$ | 2.4 | mΩ |

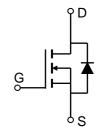








Pin Assignment



Schematic Diagram

Ordering Information

| Device | Marking | MSL | Form | Package | Tube(pcs) | Per Carton (pcs) |
|------------|---------|-----|------|-----------|-----------|------------------|
| JMSH0602PC | SH0602P | N/A | Tube | TO-220-3L | 50 | 5000 |

Absolute Maximum Ratings (@ $T_C = 25$ °C unless otherwise specified)

| Symbol | Parameter | | Value | Unit |
|------------------|----------------------------------|---------------------|----------------|---------------------------------------|
| V_{DS} | Drain-to-Source Voltage | | 60 | V |
| V_{GS} | Gate-to-Source Voltage | | ±20 | V |
| | Continuous Drain Current | $T_C = 25^{\circ}C$ | 178 | Λ |
| I _D | Continuous Diain Current | $T_C = 100$ °C | 113 | - A |
| I _{DM} | Pulsed Drain Current (1) | | Refer to Fig.4 | Α |
| E _{AS} | Single Pulsed Avalanche Energ | ly ⁽²⁾ | 697 | mJ |
| P _D | Dower Dissination | $T_C = 25^{\circ}C$ | 179 | W |
| ı, D | Power Dissipation | $T_C = 100$ °C | 71 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ |
| T_{J}, T_{STG} | Junction & Storage Temperature I | Range | -55 to 150 | °C |

Thermal Characteristics

| Symbol | Parameter | Max | Unit |
|-----------------|--|-----|------|
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient ⁽³⁾ | 68 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 0.7 | C/VV |



Electrical Characteristics (T_J = 25°C unless otherwise specified)

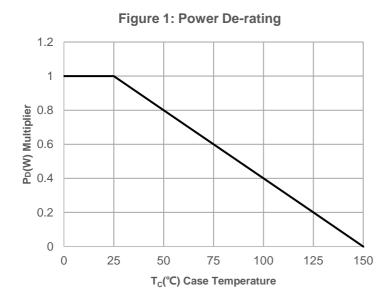
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|--|---|------|------|------|------|
| Off Cha | racteristics | | | | | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 60 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 48V, V_{GS} = 0V$ | - | - | 1.0 | μА |
| I _{GSS} | Gate-Body Leakage Current | $V_{DS} = 0V, V_{GS} = \pm 20V$ | - | - | ±100 | nA |
| On Cha | racteristics | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2.1 | 2.9 | 4.1 | V |
| R _{DS(ON)} | Static Drain-Source ON-Resistance ⁽⁴⁾ | $V_{GS} = 10V, I_D = 20A$ | - | 2.4 | 3.4 | mΩ |
| Dynami | c Characteristics | | | | | |
| R_{g} | Gate Resistance | f = 1MHz | - | 2.6 | - | Ω |
| C _{iss} | Input Capacitance | ., ., ., ., ., | 3369 | 4716 | 6367 | pF |
| C _{oss} | Output Capacitance | $V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz | 1554 | 2176 | 2938 | pF |
| C _{rss} | Reverse Transfer Capacitance | 1 - 11/11/12 | 35 | 49 | 66 | pF |
| Qg | Total Gate Charge | | 51 | 71 | 96 | nC |
| Q_{gs} | Gate Source Charge | $V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$ | 16 | 22 | 30 | nC |
| Q_{gd} | Gate Drain("Miller") Charge | V DS = 30 V, ID = 20/1 | 12 | 17 | 22 | nC |
| 0 '(-1 ' | | | | | | |
| | ng Characteristics Turn-On DelayTime | 1 | | 4.0 | _ | |
| t _{d(on)} | · | - | - | 16 | | ns |
| t _r | Turn-On Rise Time | $V_{GS} = 10V, V_{DD} = 30V$ | - | 26 | - | ns |
| t _{d(off)} | Turn-Off DelayTime | $I_D = 20A, R_{GEN} = 3\Omega$ | - | 49 | - | ns |
| t _f | Turn-Off Fall Time | | - | 24 | - | ns |
| | iode Characteristics | <u> </u> | | | 470 | Ι . |
| I _S | Maximum Continuous Body Diode Forward | | - | - | 178 | Α |
| I _{SM} | Maximum Pulsed Body Diode Forward Curre | | - | - | 712 | Α |
| V_{SD} | Body Diode Forward Voltage | $V_{GS} = 0V, I_{S} = 20A$ | - | | 1.2 | V |
| trr | Body Diode Reverse Recovery Time | I _F = 20A, di/dt = 100A/us | 51 | 71 | 96 | ns |
| Qrr | Body Diode Reverse Recovery Charge | 1 _F = 2071, dirat = 1007403 | - | 109 | - | nC |

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.\;E_{AS}\;condition:\;Starting\;T_J=25C,\;V_{DD}=30V,\;V_G=10V,\;R_G=25ohm,\;L=3mH,\;I_{AS}=21.56A,\;V_{DD}=0V\;during\;time\;in\;avalanche.$
- $3.\ R_{\theta JA}\ is\ measured\ with\ the\ device\ mounted\ on\ FR-4\ substrate\ PC\ board,\ 2oz\ copper,\ with\ minimum\ recommended\ pad\ layout.$
- 4. Pulse Test: Pulse Width $\!\!\!\!<\!300\mu s,$ Duty Cycle $\!\!\!<\!0.5\%.$



Typical Performance Characteristics



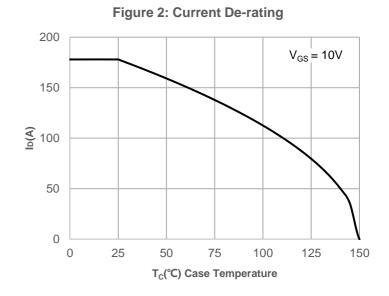
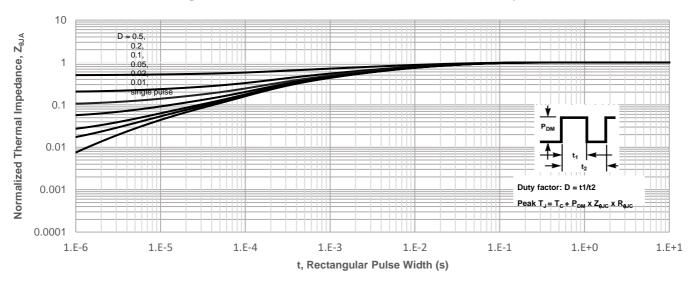
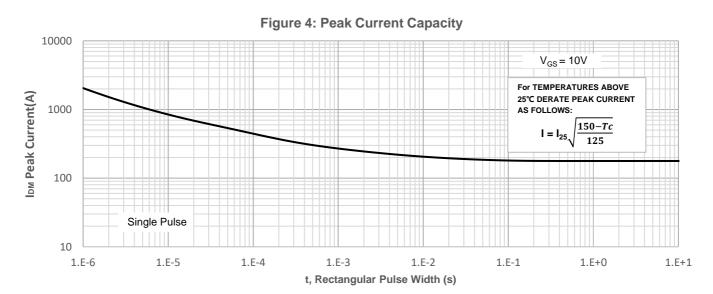


Figure 3: Normalized Maximum Transient Thermal Impedance







Typical Performance Characteristics

Figure 5: Output Characteristics

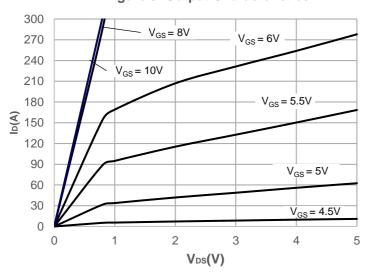


Figure 6: Typical Transfer Characteristics

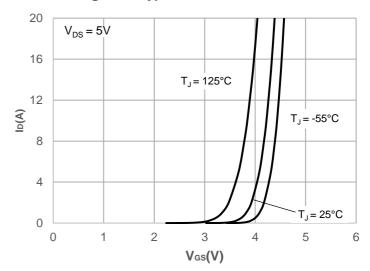


Figure 7: On-resistance vs. Drain Current

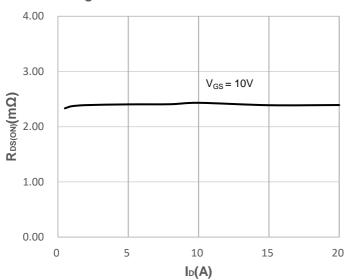


Figure 8: Body Diode Characteristics

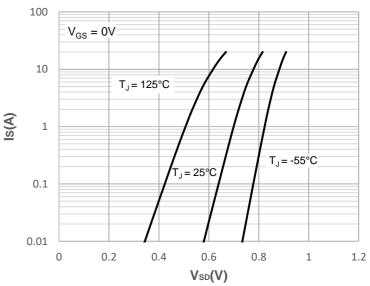


Figure 9: Gate Charge Characteristics

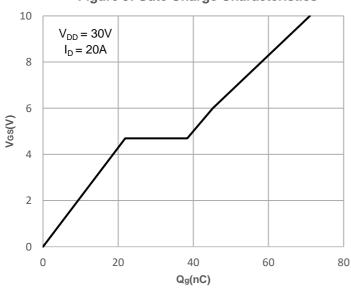
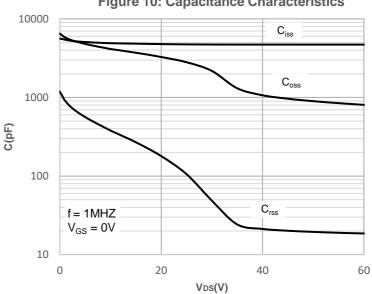


Figure 10: Capacitance Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

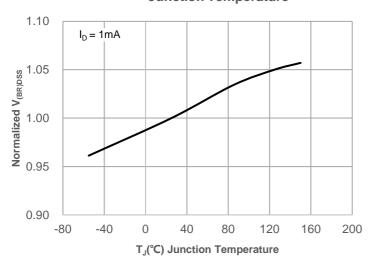


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

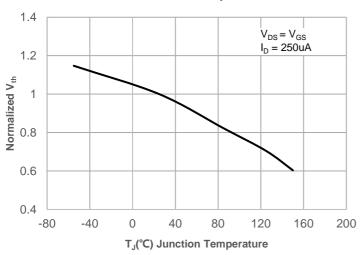


Figure 15: Maximum Safe Operating Area

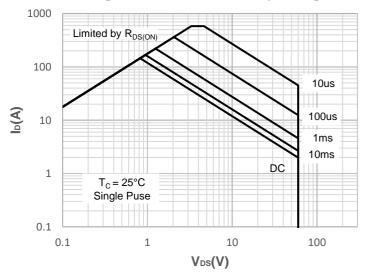
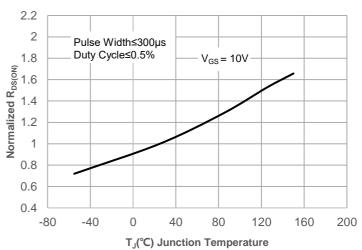
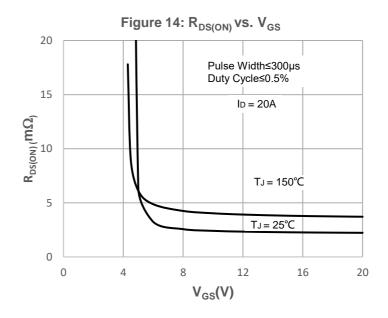


Figure 12: Normalized on Resistance vs. Junction Temperature







Test Circuit

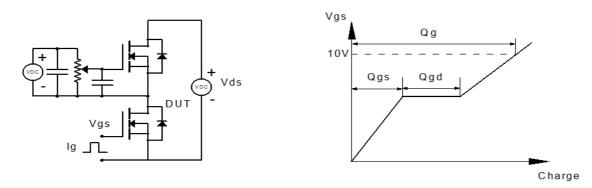


Figure 1: Gate Charge Test Circuit & Waveform

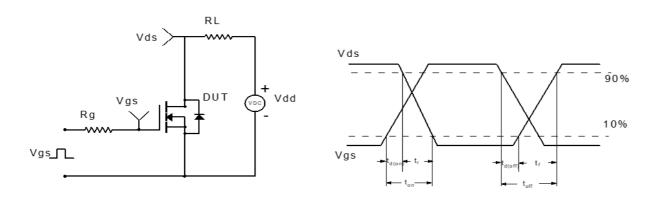


Figure 2: Resistive Switching Test Circuit & Waveform

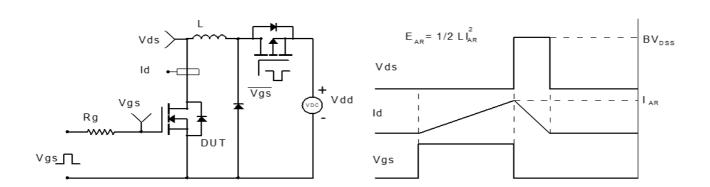


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

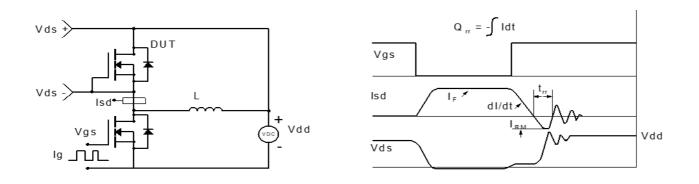
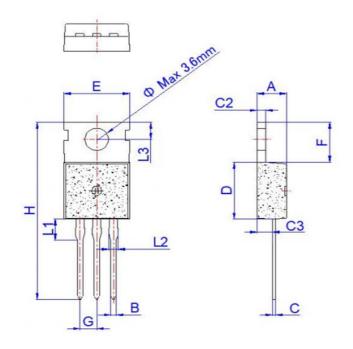


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-220-3L)



| | Dimensions | | | | | | |
|------|-------------|------|------|--------|-------|-------|--|
| Ref. | Millimeters | | | Inches | | | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. | |
| Α | 4.40 | | 4.60 | 0.173 | | 0.181 | |
| В | 0.70 | | 0.90 | 0.028 | | 0.035 | |
| C | 0.45 | | 0.60 | 0.018 | | 0.024 | |
| C2 | 1.23 | | 1.32 | 0.048 | | 0.052 | |
| C3 | 2.20 | | 2.60 | 0.087 | | 0.102 | |
| D | 8.90 | | 9.90 | 0.350 | | 0.390 | |
| E | 9.90 | | 10.3 | 0.390 | | 0.406 | |
| F | 6.30 | | 6.90 | 0.248 | | 0.272 | |
| G | | 2.54 | | | 0.1 | | |
| Н | 28.0 | | 29.8 | 1.102 | | 1.173 | |
| L1 | | 3.39 | | | 0.133 | | |
| L2 | 1.14 | | 1.70 | 0.045 | | 0.067 | |
| L3 | 2.65 | | 2.95 | 0.104 | | 0.116 | |
| Φ | | 3.6 | | | 0.142 | | |

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